



---

DESIGN FOR MANUFACTURING 2008

# "NO DESIGN FOR MANUFACTURING"

---

May 21, 2008

**\*Team name : Icarus**

**\*\*Members : Min-seang Kim**

**Yun-mi Kim**

**Adrian Paulo Garcia Avila**

# Contents

---

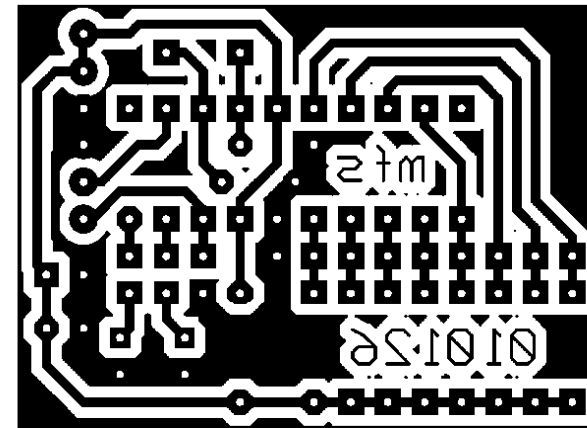


- **Introduction**
  - Concept
  - Objectives
- **Fabrication method**
- **Study literature**
  - Patents
  - Related researches
- **Property test & Analyses**
  - Bonding test
  - Conductivity test
  - Composition analysis
  - Cost analysis
- **Future Work**

# Introduction



## ▪ Concept



- Electronic goods have an electrical circuit.
- Interconnection of resistors, inductors, capacitors, and etc.
- Conduction line does not have cross section.
  - **Substrate needs sufficient space**
- Insulator on a cross point



# Introduction (cont.)

---

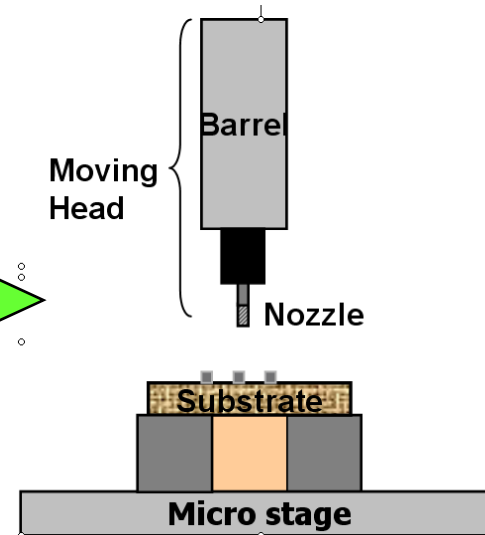
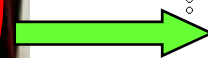
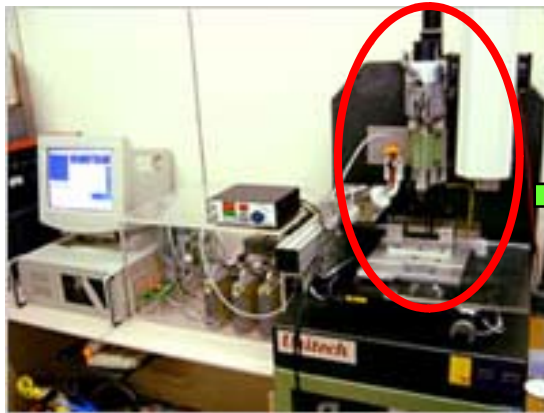
- **Objectives**

- To connect all element by straight line having cross sections.
  - Making small electric circuit with easy way.
  - New technique for an easy & fast way to make an electrical circuit.

# Fabrication Method



- Rapid prototyping



- Experimental conditions

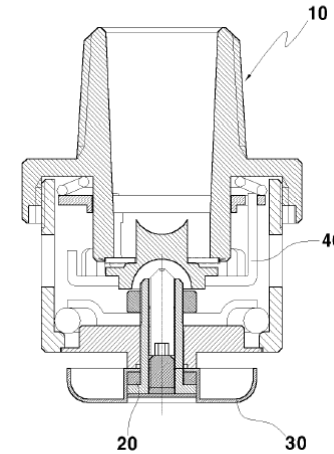
Nozzle speed	Nozzle Dia.	Cylinder Temp.	Air pressure	Height (from nozzle to board)
1.5 mm/s	500 $\mu\text{m}$	160 $^{\circ}\text{C}$	11 KPa	47 mm

# Studing literature

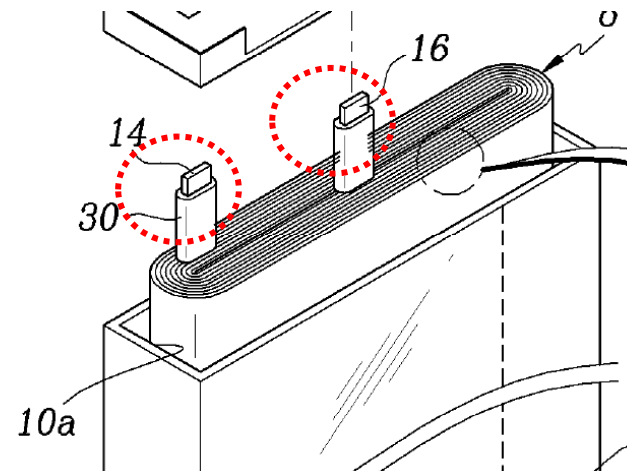
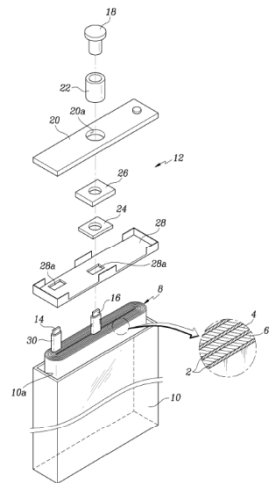


- Patents: internal

**Detector of  
springcooler**  
(10-2008-  
0023001)



**Soldering  
method  
in secondary  
battery**  
(10-2003-  
0039571)

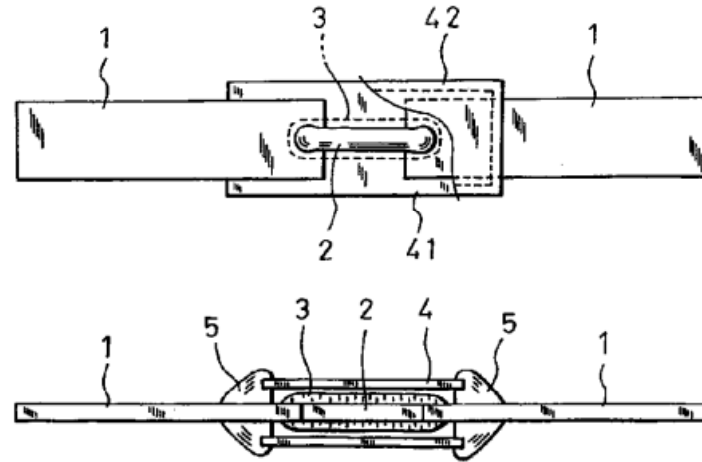


# Studying literature (cont.)

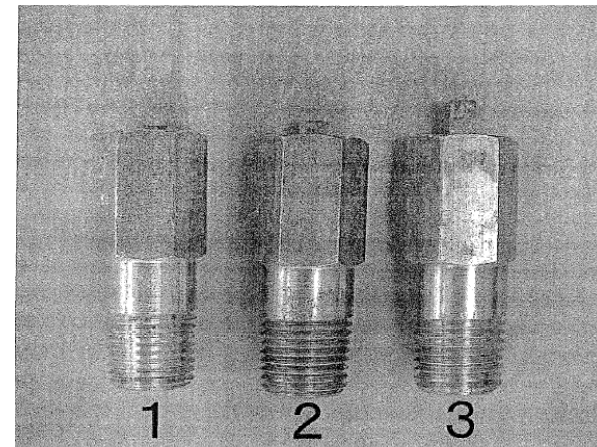
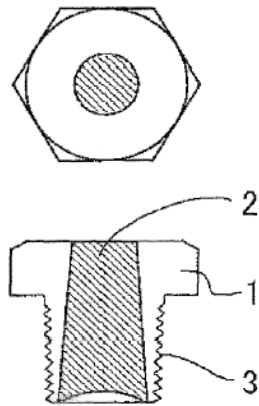


## Patents: international

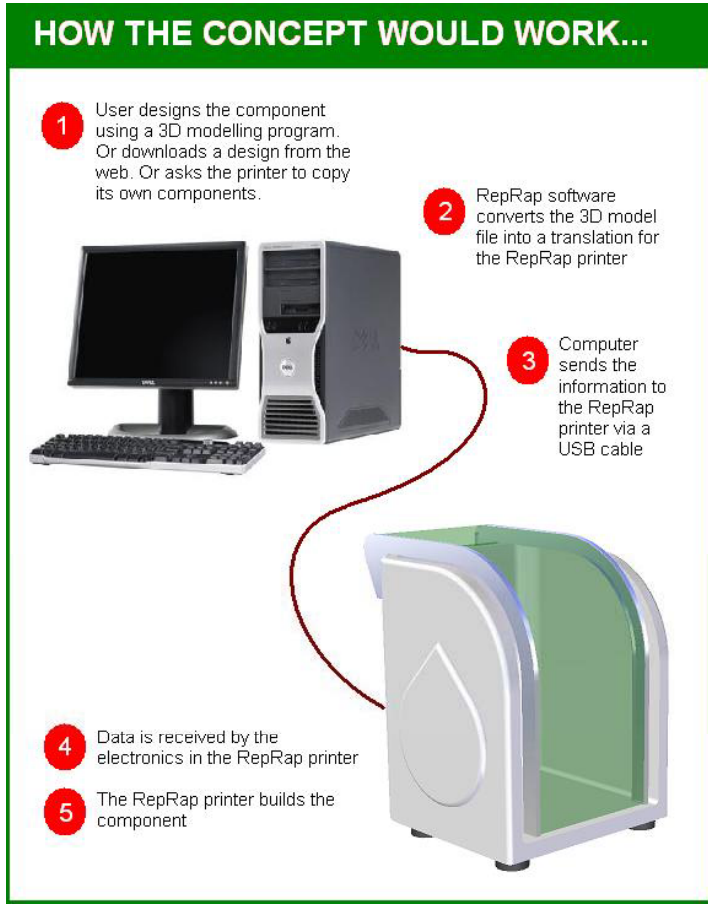
**Thermal Fuse**  
(US  
6,911,892,B2)



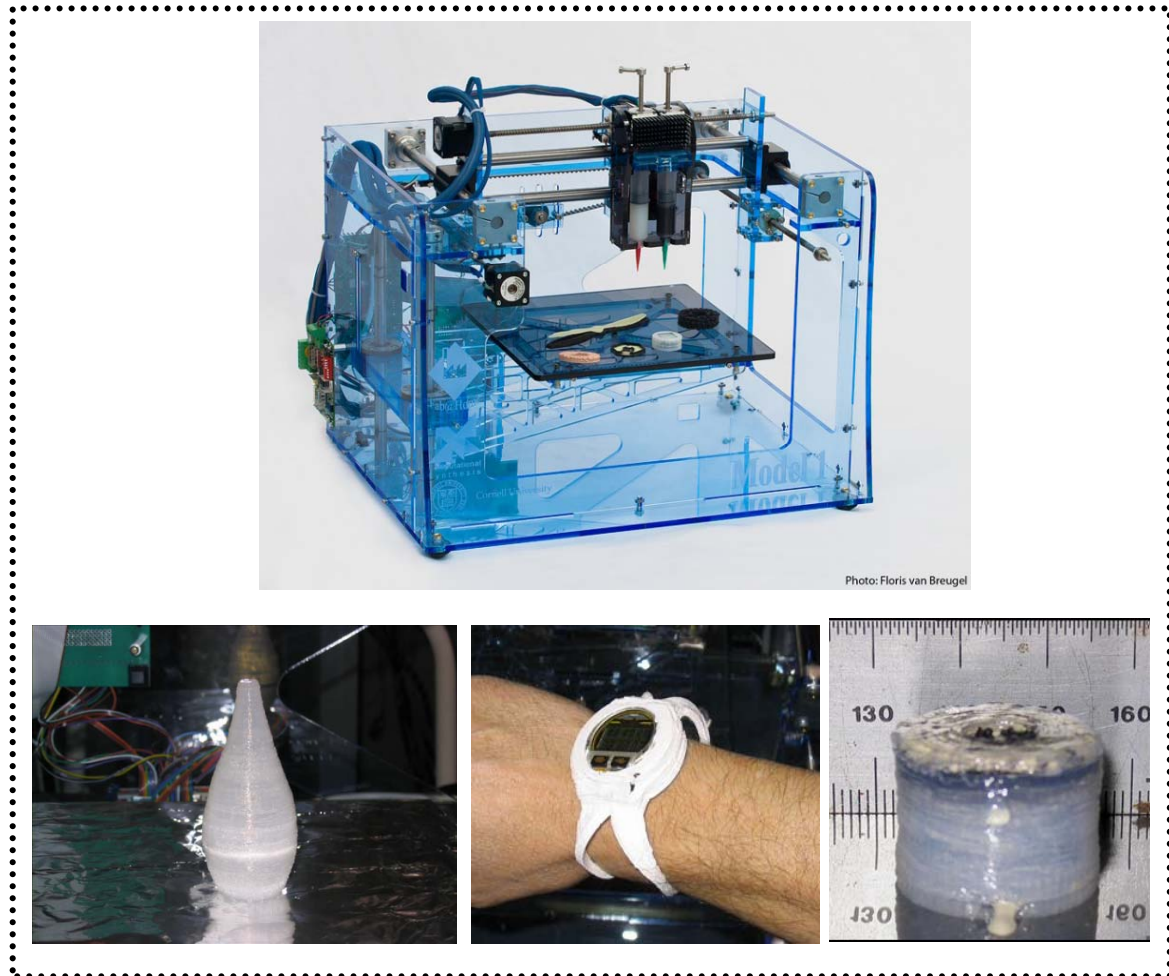
**Fusible plug**  
(WO 2006/  
057029)



# Studying literature (cont.)



The concept of 3D printer

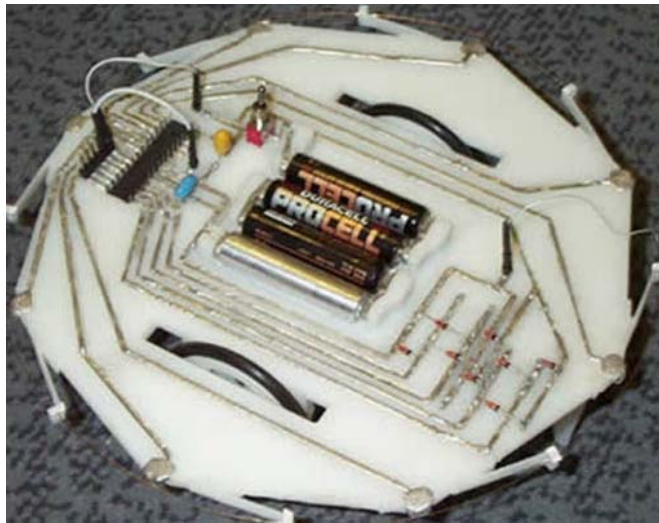


3D printer & stuffs  
Ref.> Fab@Home



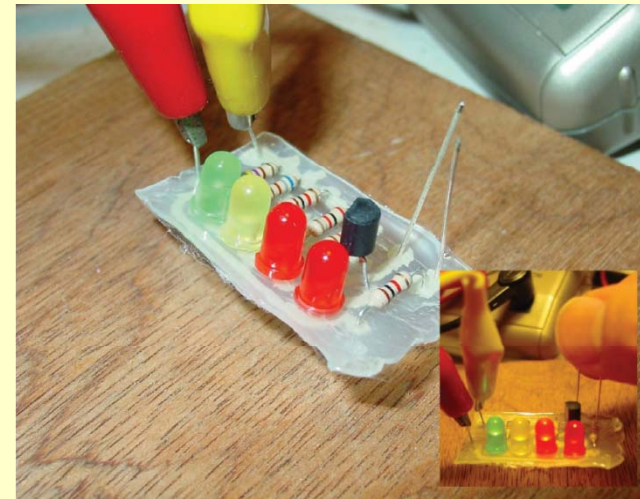
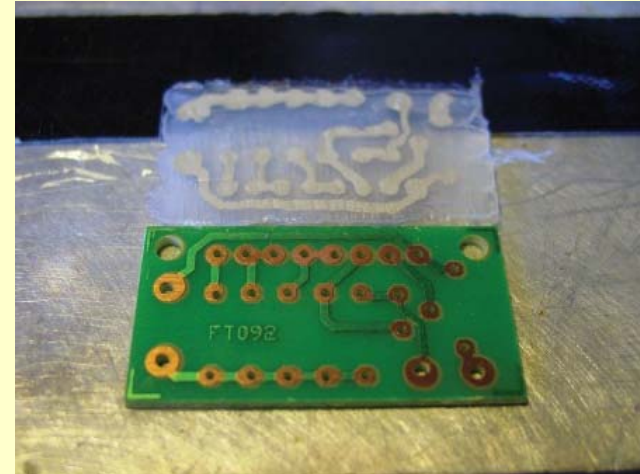


# Studying literature (cont.)



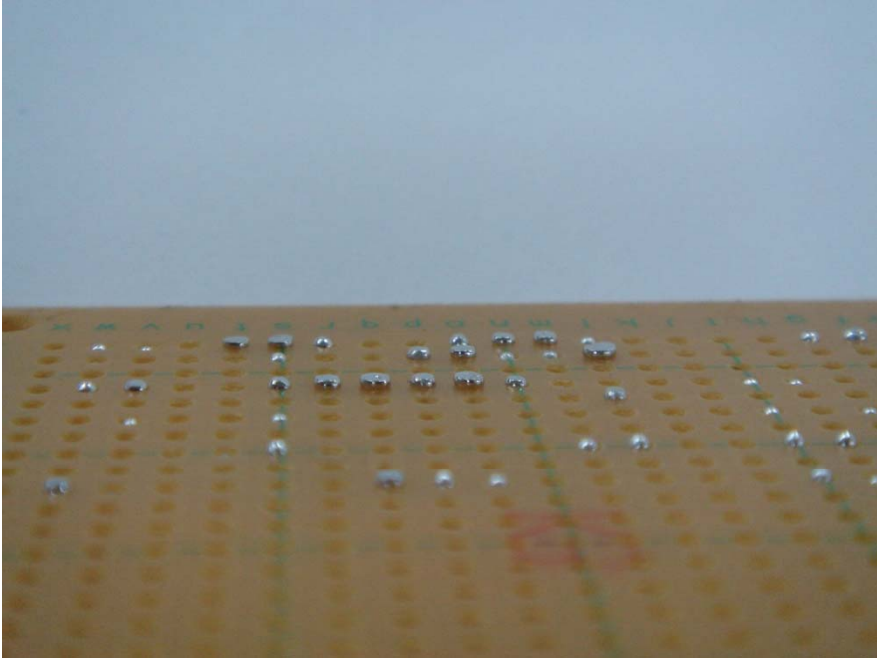
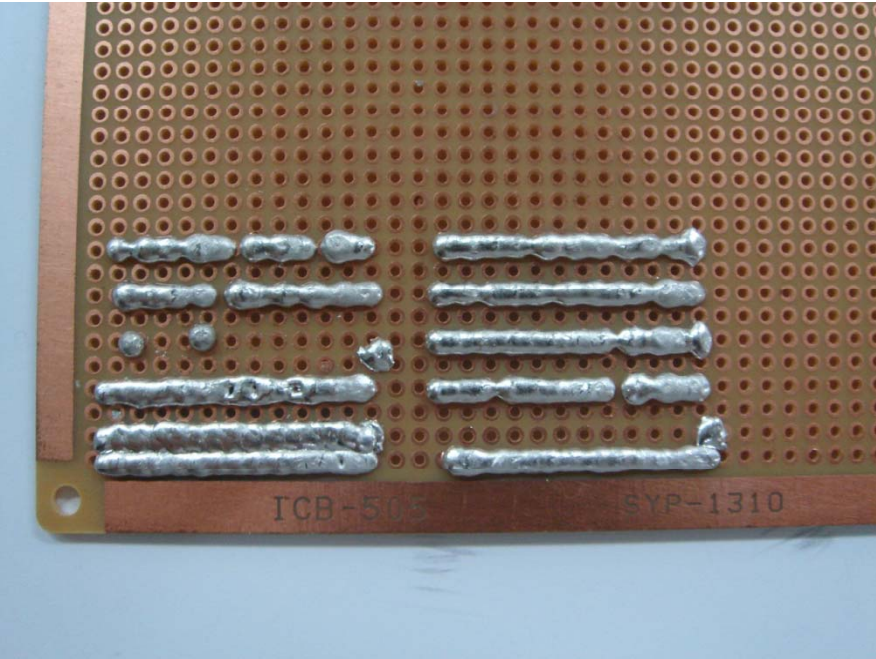
Printed circuit with fusible alloy

Ref.> <http://reprap.org/bin/view/Main/AdrianBowyer>

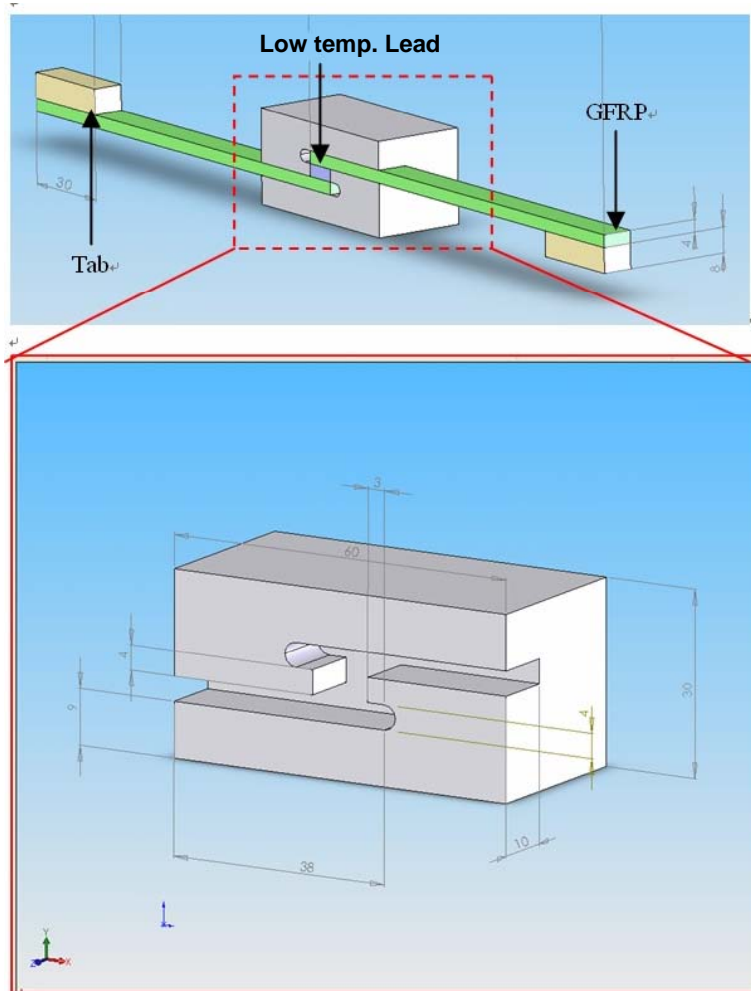


Construction of PCBs Using Sliver Paint and EVA Hot-Melt Glue  
Ref.> **diamond ace solution LTD.**

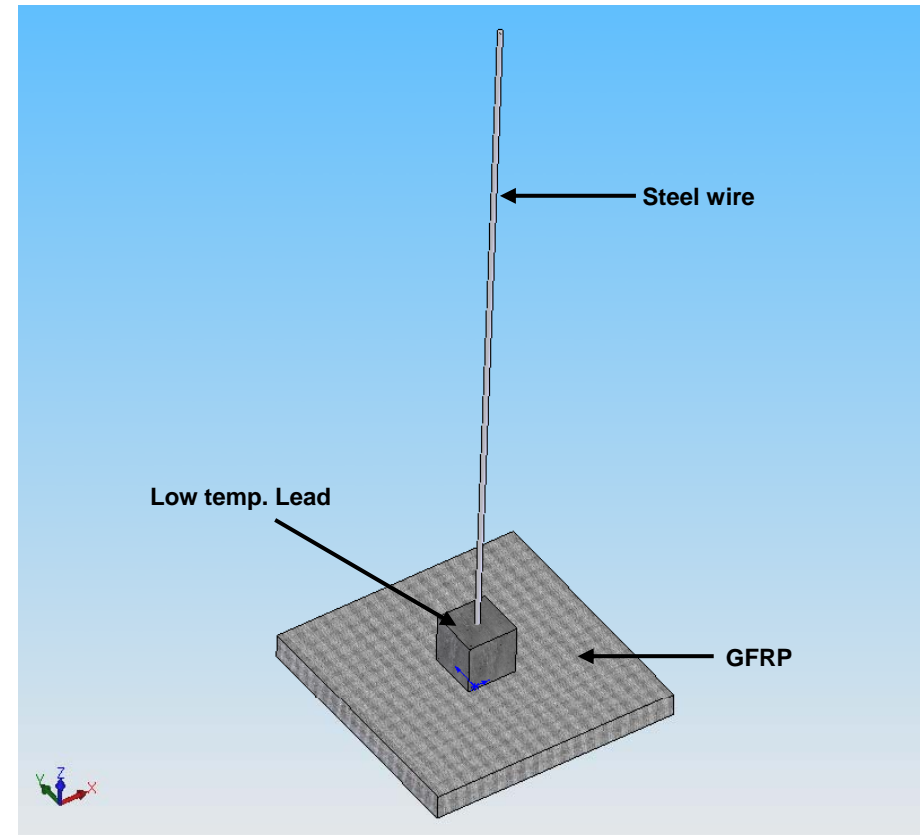
# Bonding Mechanism



# Bonding Test



< Plan 1 >

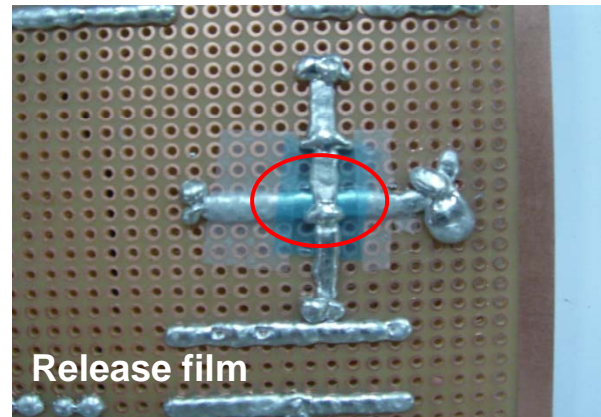
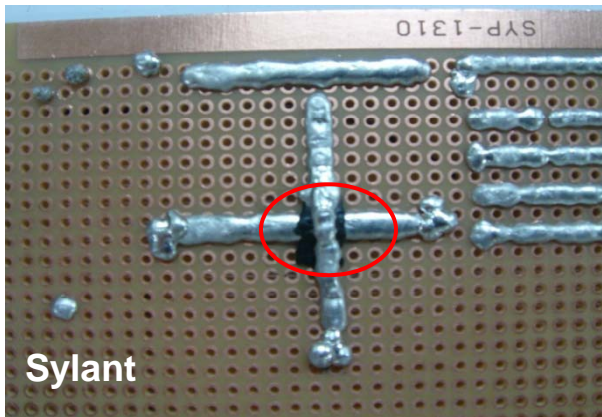


< Plan 2 >

# Cross point checking



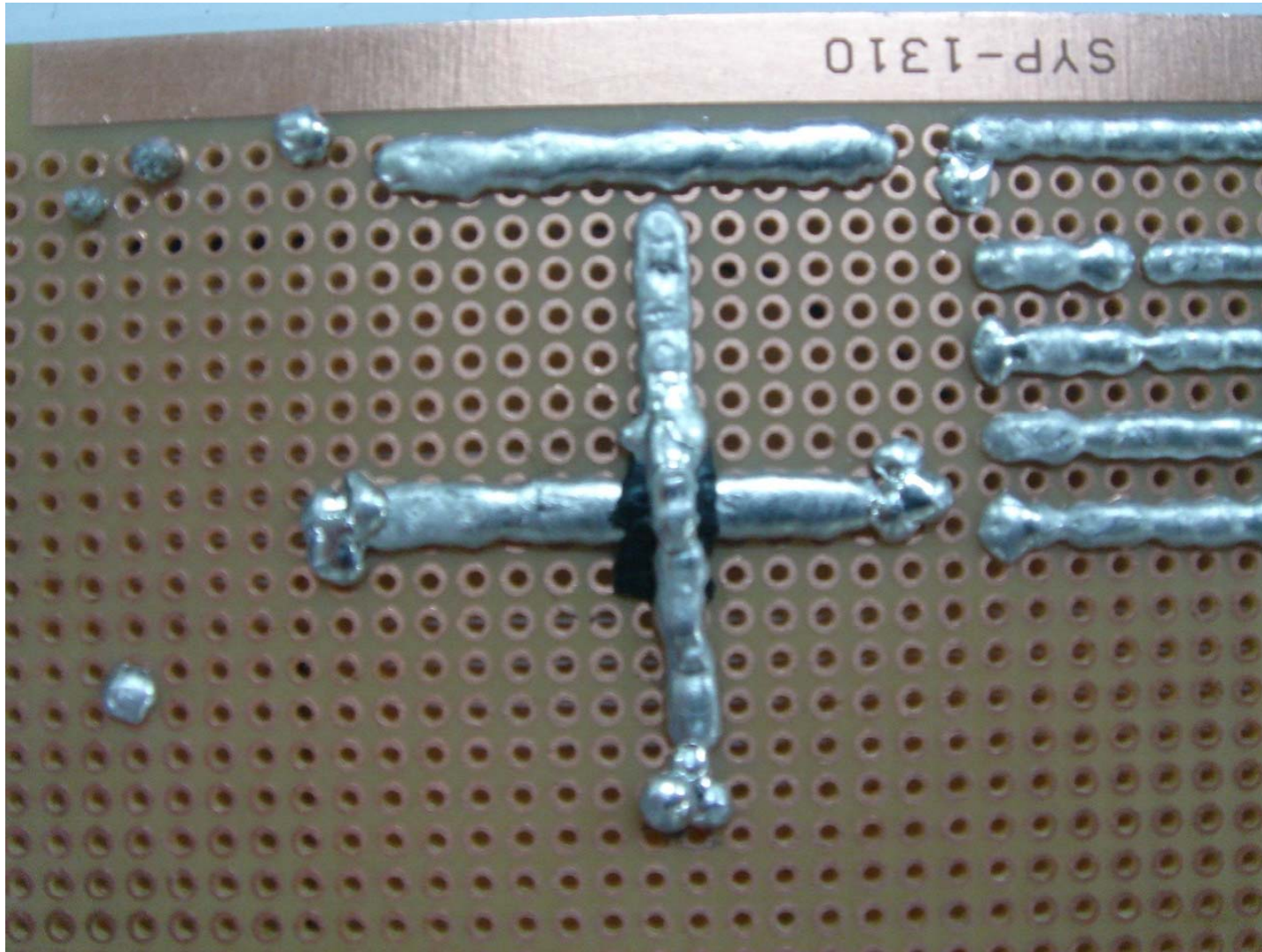
- **Cross point should be checked.**
  - A short is an accidental low-resistance connection between two nodes of an electrical circuit.
  - A short can cause circuit damage, overheating, fire or explosion
- **Requirements of insulation material**
  - Don't melt at 160°C
  - Good bonding with line
  - Insulation material : **Sylant , Release film**



- **Each line have a good conductivity.**

Ref>[http://en.wikipedia.org/wiki/Short\\_circuit](http://en.wikipedia.org/wiki/Short_circuit)

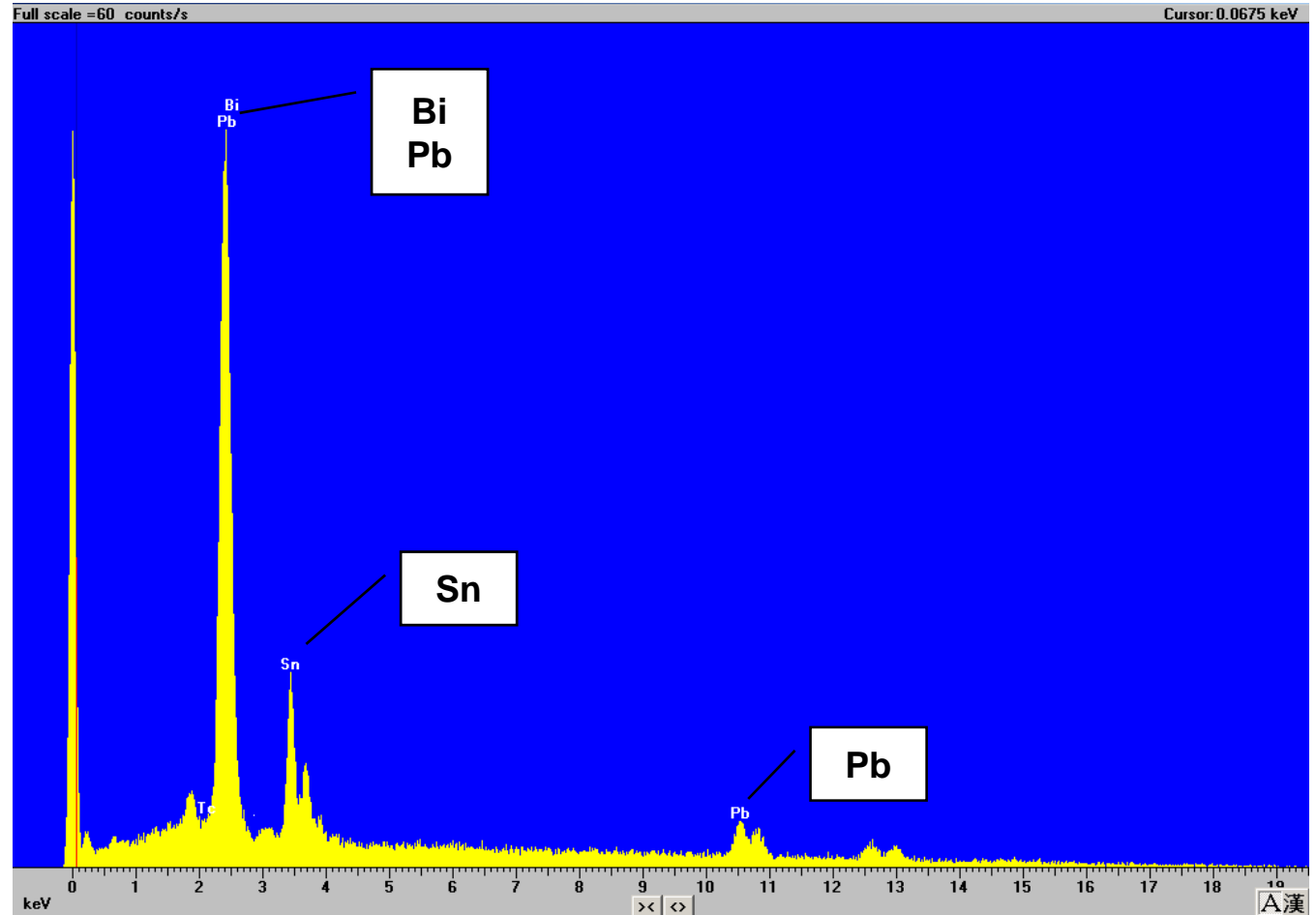
# Conductivity Test



# Composition analysis



- Low melting point lead
- Melting temp. : 105°C



# Cost analysis



## Cost model

- The total cost of plate fabrication:  $C_{total} = C_w + C_f$

<i>Material cost</i>	<i>Fabrication cost</i>
$C_w$	$C_f$
$C_w = V\rho C_{um}$	$C_f = WT_f$

*V*: material volume  
*ρ*: density  
*C<sub>um</sub>*: unit price of material

*W*: wage per hour  
*T<sub>f</sub>*: preparation time (hour)

Item	Hand made		RP printing	
$C_w$ (Material cost)	Perf board (₩3,100 /100mm×100mm)	₩3,100	Perf board (₩1100 /50mm×50mm)	₩1,100
	Element (₩5,000 /1set)	₩5,000	Element (₩5,000 /set)	₩5,000
	Soldering lead(₩21,100 /1kg)	₩1,050	Low temp. lead (₩35,000/1kg)	₩3,500
Subtotal		₩9,150		₩9,600
$C_p$ (Preparation cost)	<i>T<sub>p</sub></i> , heating a small heart-shaped iron	5min	<i>T<sub>p</sub></i> , heating RP machine	10 min
	<i>T<sub>p</sub></i> , assembling elements	20 min	<i>T<sub>p</sub></i> , assemble elements	5min
	<i>T<sub>m</sub></i> , Soldering wire and elements	30min	<i>T<sub>m</sub></i> , Printing on a perf board	5min
	W	₩6,550 / hr	W	₩6,550 / hr
Subtotal		₩6,010		₩2,180
<b>Total</b>		<b>₩15,160 /ea</b>		<b>₩11,780 /ea</b>

# Cost analysis (cont.)

---



## ▪ Cost estimation

- Per part cost of hand made and RP printing
  - Hand made circuit (₩15,160), RP printing (₩11,780)
- Cost of RP printing
  - Mass production cost of 1,000 unit
    - Material cost:  $C_w \times 1,000$
    - Preparation cost: assembling cost  $\times 1,000$  + printing cost  $\times 1,000$  + Heating cost
    - Per part cost: ₩10,255

## ▪ Assumption

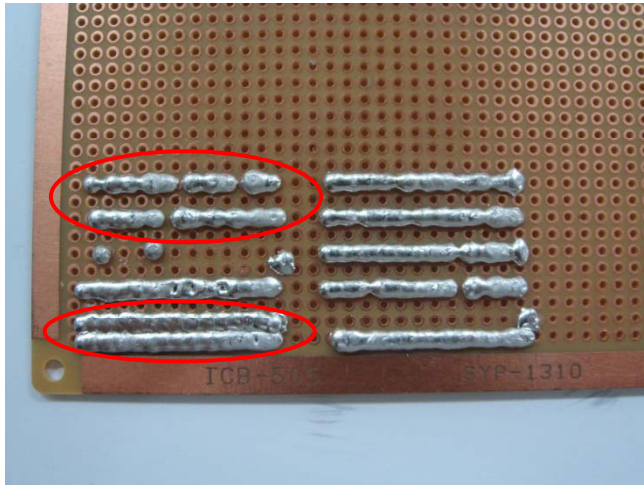
- Labor cost : 6,550 won/hour
- Market research : <http://elparts.co.kr/>
- Depreciation cost : no considering



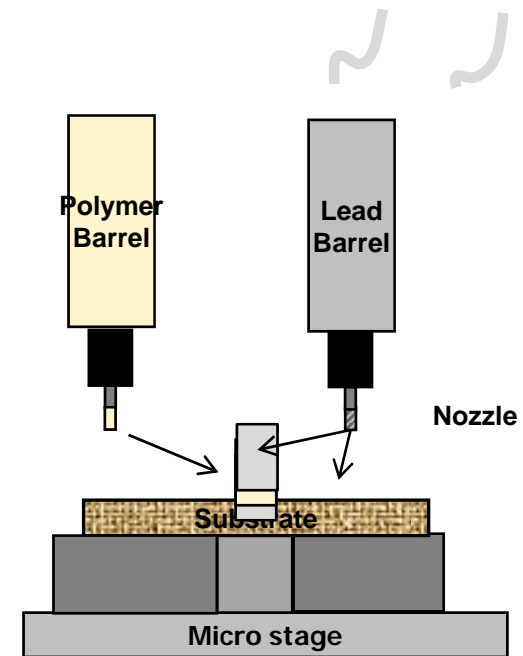
# Future work



- **Improvement line shape**
  - Make more thin and beautiful line



- **Improvement insulation material and method**
  - Sylant , Release film → Polymer
  - Attach by hands → Deposition
- **Bonding test**





**Thank you**